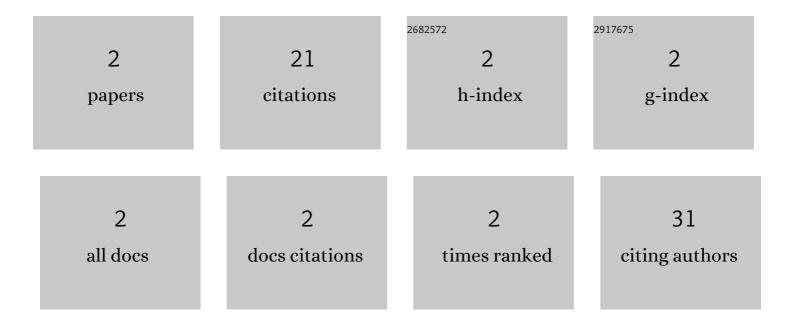
Benoit Thollin

List of Publications by Year in descending order

Source: https://exaly.com/author-pdf/2403607/publications.pdf Version: 2024-02-01



#	Article	IF	CITATIONS
1	Direct Copper Bonding for Power Interconnects: Design, Manufacturing, and Test. IEEE Transactions on Components, Packaging and Manufacturing Technology, 2015, 5, 143-150.	2.5	17
2	Numerical and Experimental Evaluation of the Microsecond Pulsed Heating Curve Technique Dedicated to Die Interconnection Characterization. IEEE Transactions on Components, Packaging and Manufacturing Technology, 2016, 6, 835-845.	2.5	4